Measurements of stress and fracture in germanium electrodes of lithium-ion batteries during electrochemical lithiation and delithiation

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\textbf{HIGHLIGHTS}

\begin{itemize}
\item Stresses were measured in-situ in a-Li\textsubscript{x}Ge during electrochemical cycling.
\item a-Li\textsubscript{x}Ge was found to flow plastically at significantly lower stresses than a-Li\textsubscript{x}Si.
\item The elastic modulus was measured in a-Li\textsubscript{x}Ge as a function of lithium concentration.
\item The fracture energy of a-Li\textsubscript{x}Ge was measured, indicating a brittle material.
\item a-Li\textsubscript{x}Ge exhibits an unusual combination of plastic flow and brittle fracture.
\end{itemize}

\textbf{ABSTRACT}

We measure stresses that develop in sputter-deposited amorphous Ge thin films during electrochemical lithiation and delithiation. Amorphous Li\textsubscript{x}Ge electrodes are found to flow plastically at stresses that are significantly smaller than those of their amorphous Li\textsubscript{x}Si counterparts. The stress measurements allow for quantification of the elastic modulus of amorphous Li\textsubscript{x}Ge as a function of lithium concentration, indicating a much-reduced stiffness compared to pure Ge. Additionally, we observe that thinner films of Ge survive a cycle of lithiation and delithiation, whereas thicker films fracture. By monitoring the critical conditions for crack formation, the fracture energy is calculated using an analysis from fracture mechanics. The fracture energies are determined to be $\Gamma = 8.0$ J m\textsuperscript{-2} for a-Li\textsubscript{0.3}Ge and $\Gamma = 5.6$ J m\textsuperscript{-2} for a-Li\textsubscript{1.6}Ge. These values are similar to the fracture energy of pure Ge and are typical for brittle fracture. Despite being brittle, the ability of amorphous Li\textsubscript{x}Ge to flow at relatively small stresses during lithiation results in an enhanced ability of Ge electrodes to endure electrochemical cycling without fracture.

\textbf{1. Introduction}

Lithium ion batteries provide power for an increasing number of applications, particularly in portable electronic devices and electric vehicles [1–4]. On the anode side, silicon has received much attention due to its extremely high specific capacity (\textasciitilde 3579 mAh g\textsuperscript{-1}) [5], which is almost ten times larger than that of the commercial anode of choice, graphite (\textasciitilde 372 mAh g\textsuperscript{-1}) [5–8]. However, lithiation of silicon causes an enormous increase in volume of \textasciitilde 280\%, which can result in large stresses and fracture under constraint [9–45]. Fracture leads to loss of active material and creates more surface area for solid-electrolyte interphase (SEI) growth, both of which substantially contribute to capacity fade in the system [9–13]. This
mechanical degradation has been mitigated to varying degrees of success via nano-structuring of the electrodes, but it remains an important issue in constructing practical silicon anodes [14–24]. Germanium, another group IV element, has garnered relatively little attention as an anode material despite its comparatively large theoretical charge density: \(-7370\ \text{mAH cm}^{-3}\) for \(\text{Li}_x\text{Ge}\) versus \(-8330\ \text{mAH cm}^{-3}\) for \(\text{Li}_x\text{Si}\) [46]. Furthermore, both the electronic conductivity of Ge and the diffusivity of Li within Ge have been reported to be much larger than those of Si, thereby making Ge a promising candidate for high-rate applications (e.g., high-power applications) [14,47]. Still, prior to implementation of Ge as a practical anode material, it is important to evaluate its mechanical performance during electrochemical cycling.

To date, relatively few studies have examined mechanical characteristics of germanium anodes. Using in-situ transmission electron microscopy in Ge nanowires, Liu et al. found the volumetric expansion upon lithiation to be nearly isotropic and highly reversible upon delithiation [48]. Liang et al. also found highly reversible isotropic swelling and de-swelling of crystalline Ge nanoparticles upon lithiation and delithiation [49]. Moreover, they observed no fracture, even during multiple cycles, for particles with an initial diameter as large as 620 nm [49]. This resistance to fracture was attributed to the isotropic nature of lithiation [49], which is in stark contrast to the highly anisotropic lithiation observed in crystalline silicon electrodes [9,10,25,26]. The anisotropic lithiation of c-Si leads to stress concentrations, thereby increasing the driving force for fracture relative to the isotropic (e.g., Ge) case. Lee et al. found a critical pillar diameter of 1.2 mm for fracture of \(<111\>\) axially oriented Ge nanopillars [50]. They also attributed this larger critical size than that of Si nano-pillars (\(-300\) nm) to the nearly isotropic lithiation of Ge [50]. Overall, these studies suggest improved mechanical robustness of crystalline Ge electrodes compared to their crystalline Si counterparts. However, studies aimed at experimental quantification of mechanical properties of Li,Ge are lacking. In particular, measurements of quantities such as the elastic modulus, the fracture energy, and the stresses that develop during electrochemical cycling are essential for enabling practical designs of Ge electrodes that avoid mechanical degradation.

In this study, we have performed mechanical measurements of a-\(\text{Li}_x\text{Ge}\) electrodes in-situ during electrochemical cycling. In particular, we have measured the stresses that develop during lithiation and delithiation as a function of lithium concentration. The a-\(\text{Li}_x\text{Ge}\) electrodes were observed to flow plastically and develop smaller stresses than their a-\(\text{Li}_x\text{Si}\) counterparts. These in-situ stress measurements also allowed for quantification of the elastic modulus of a-\(\text{Li}_x\text{Ge}\). Furthermore, we observed that thinner films of germanium survive a cycle of lithiation and delithiation, whereas thicker films fracture. The fracture energy was calculated based on the critical conditions for crack formation using an analysis from fracture mechanics. Overall, these measurements indicate an enhanced ability of Ge electrodes to endure electrochemical cycling without fracture relative to their silicon counterparts.

2. Experimental procedures

Glass substrates with a thickness of 1 mm were cleaned with acetone and isopropanol, and placed into a sputter deposition system (AJA Int. ATC 1800) with a base pressure of \(<10^8\) Torr. All depositions were performed at room temperature (22 °C), using sputtering targets with a 50.8 mm diameter. First, the substrates were plasma-cleaned in Ar at 20 mTorr using an RF power of 24 W for 5 min. Next, 15 nm of Ti was sputtered onto the substrates using a pressure of 3 mTorr of Ar and a DC power of 100 W for 5 min. A 300 nm layer of Cu was then deposited using a pressure of 5 mTorr of Ar and a DC power of 100 W for 15 min. The Cu film served as current collector, while the Ti under-layer was used to improve the adhesion between the Cu film and the glass substrate. Finally, films of Ge with varying thickness were deposited using a pressure of 5 mTorr of Ar and a DC power of 100 W. The working area of each Ge electrode was 8 mm by 30 mm.

Electrochemical cells were assembled in a glove box maintained at a moisture level of less than 1 ppm, using a 1M solution of LiPF\(_6\) in 1:1:1 (weight %) ethylene carbonate: diethyl carbonate: dimethyl carbonate as the electrolyte. Electrochemical measurements were performed with a VersaSTAT 3 galvanostat from Princeton Applied Research. The electrodes were lithiated at a C/16 rate (assuming a specific capacity of 1384 mAH g\(^{-1}\) for \(\text{Li}_x\text{Ge}\) and a density of pure Ge of 5.32 g cm\(^{-3}\) [51,52]) to a cutoff voltage of 50 mV. Delithiation was performed at the same rate to a cutoff voltage of 2 V.

Stresses in the Ge films were measured by monitoring the curvature of the substrate during lithiation and delithiation. The stresses in the films were calculated using Stoney’s equation [53,54],

\[
\sigma = \frac{E_s h^3}{6 h_f (1 - \nu_s)} \Delta K,
\]

where \(\sigma\) represents the average stress in the film, \(\sigma\) is the residual stress in the as-deposited Ge film, \(E_s\) is the elastic modulus of the substrate, \(h\) is the thickness of the substrate, \(\nu_s\) is Poisson's ratio of the substrate, and \(\Delta K\) is the change in curvature of the substrate induced by changes in the stress in the film. The residual stress in the as-deposited Ge film was determined by measuring the curvature of the glass substrate before and after Ge deposition. In the calculations, values of \(E_s = 72\ \text{GPa}\) and \(\nu_s = 0.23\) were used for the glass substrate [55].

The change in curvature of the substrate was monitored with a multi-beam optical sensor (MOS) from k-Space Associates. For more details on this method, please see Ref. [29]. The change in the curvature of the substrate was calculated from the geometric relation,

\[
\Delta K = \frac{d_0 - d}{d_0} \cos \alpha \left[ \frac{\cos \alpha}{2L} \right] n_s n_t
\]

where \(d\) is the distance between two adjacent laser spots measured on the CCD camera of the sensor, \(d_0\) is the initial distance between the laser spots, \(\alpha\) is the angle of reflection of the laser beams, \(L\) is the distance between the electrochemical cell and the CCD camera, and \(n_s\) and \(n_t\) are the indices of refraction of air and the electrolyte, respectively. In the calculation of the stress, we took \(n_s = 1.42\) for the electrolyte [56] and \(n_t = 1\) for air.

Since the Ge thin-film electrodes were constrained in the plane of the film by the relatively thick substrate, lithium insertion was accommodated entirely by expansion in the thickness direction. As a result, we take the thickness of the film as linear in the state of charge,

\[
h_t = h_f (1 + \beta s),
\]

where \(h_f\) is the initial thickness of the film, \(\beta\) is related to the atomic volumes (\(\Omega\)) of Ge and the lithiated phase by \(\beta = (4\Delta\Omega \text{Ge} – 12\Omega_2)/12\Omega_2 = 2.6\), and \(s\) is the state of charge of the electrode, with a value of 0 representing pure silicon and a value of 1 representing the fully lithiated state (assumed to be \(\text{Li}_x\text{Ge}\) with a capacity of 1385 mAH g\(^{-1}\)). The state of charge was inferred from the experimental time during the galvanostatic experiments. The value of 2.6 was taken from Liang et al., who found that germanium undergoes a 260% increase in volume upon full lithiation [49].

Each of the thin-film electrodes was scratched with a diamond scribe to introduce imperfections off of the sidewalls of the cracks with sizes on the order of the film thickness. This technique initiates channel cracks through the thickness of the film so that the fracture analysis by Beuth [57] (analyzed in the Results and Dis-
For more details on the cut-off potential of 50 mV and then delithiated at the same current density (C/16 rate assuming a capacity of 1384 mAh g\(^{-1}\)), three of which were disconnected one by one at various cut-off potentials of 300 mV, 130 mV, and 50 mV to reach different states of charge. The remaining four electrodes were further lithiated to a potential of 300 mV, 130 mV, and 50 mV to reach different states of charge. The remaining four electrodes were further lithiated to a cut-off potential of 50 mV and then delithiated at the same current density (12.6 μA cm\(^{-2}\)). These electrodes were disconnected one by one from the cell at various potentials (380 mV, 460 mV, 680 mV, 2000 mV), such that they were only partially delithiated. The diffraction patterns of these samples were measured using Cu K\(_\alpha\) radiation in a D2 Phaser (Bruker). The electrodes were sealed under an Ar atmosphere in an airtight polyethylene sample holder from Bruker; the XRD experiments were done on the samples in this holder without exposure to air. All XRD measurements were performed at room temperature at a rate of 5 s per step and a step size of 0.02°.

Nanoindentation experiments were employed to measure the elastic modulus of the as-deposited Ge films. Tip calibrations were executed using fused silica as a reference material, and machine compliances were subtracted out using a standard approach. The experiments were performed using the same deposition conditions as outlined above on 900 nm as-deposited Ge films on glass slides with 10 nm Ti adhesion layers. Indentations were made with an iNano nanoindenter (Nanomechanics Inc., Oak Ridge, TN) equipped with a Berkovich tip using established techniques [58,59]. The elastic modulus was determined from contact stiffness measurements obtained for indentations at a depth of 90 nm (10% of the film thickness).

### 3. Results and Discussion

Fig. 1 shows the responses of the potential and stress during galvanostatic lithiation and delithiation of Ge electrodes with various thicknesses. During lithiation, the voltage in Fig. 1a gradually decreases as the state of charge increases, and the opposite occurs during delithiation. These gradually sloping voltage profiles suggest a single-phase reaction, which may occur due to the slow charging rate (C/16) used in the experiments.

To further investigate this point, Fig. 2 shows XRD patterns of lithiated Ge at various potentials versus Li/Li\(^{+}\), both during lithiation and delithiation. The patterns at 300 mV, 130 mV, and 50 mV correspond to lithiation, while 380 mV, 460 mV, 690 mV, and 2000 mV correspond to delithiation. The peaks at approximately 43° and 50° are from the Cu current collector, while the peak at 38° is attributed to the Ti adhesion layer. No other peaks can be observed in the as-deposited Ge sample, indicating that the sputter-deposited Ge film is amorphous. During lithiation, there is no significant change in the peaks all the way down to the cutoff voltage of 50 mV. In addition, no changes in the peaks are detected during delithiation, indicating that the Li–Ge compound in our experiments remained amorphous during the lithiation cycle. In contrast, several researchers have reported that lithiation of Ge electrodes involves a two-step phase transformation: a-Ge (or c-Ge) \(\rightarrow\) a-Li\(_x\)Ge \(\rightarrow\) c-Li\(_{15}\)Ge\(_4\).
converted to a-Li$_x$Ge in a core-shell geometry, followed by conversion of the a-Li$_x$Ge to c-Li$_{15}$Ge$_4$. In addition, Baggetto and Notten performed XRD measurements on evaporated and sputtered a-Ge electrodes to observe the phase transformations during lithiation and delithiation [52]. They suggested that a phase transformation of a-Li$_x$Ge to c-Li$_{15}$Ge$_4$ takes place between 130 mV and 20 mV [52].

We surmise that the difference between our experiments and others may be due to the Ge deposition conditions, the relatively slow charging rates, and/or the relatively large lower cutoff potential used in our experiments (50 mV). In any event, the XRD data suggests that in our experiments Li$_x$Ge remained amorphous throughout electrochemical cycling.

As lithium is first inserted, the compressive stress in the electrodes rises rapidly until it reaches a value of 800–900 MPa (Fig. 1b). At that point, the Li$_x$Ge yields and the stress reduces upon further lithium insertion. The stress in this regime corresponds to the flow stress of lithiated Ge. The data in Fig. 1b show that the reduction in flow stress with increasing lithium content is quite substantial — for instance, the flow stress of Li$_{3.2}$Ge is approximately 270 MPa. Upon delithiation, there is an initial elastic regime, during which the stress rapidly increases as lithium is extracted. This regime is followed by yield in tension and a gradual increase in flow stress with reducing lithium concentration. For the 320 nm and 1160 nm films, there is a peak in the flow stress, which is followed by an apparent drop in stress with further delithiation.

The observation of plastic deformation in the Li$_x$Ge electrodes is critical, because plastic flow limits the stresses that build up during delithiation. In particular, the energy release rate, G, i.e., the driving force for fracture, scales as

$$G \propto \sigma^2 h / E_f,$$  \hspace{2cm} (4)

where $\sigma$ is the stress in the film, $h$ is the thickness of the film, and $E_f$ is the elastic modulus of the film [32]. If the deformation were entirely elastic, the stress in the film would be $\sigma = E_f$. Due to the enormous strains $\epsilon$ associated with lithium insertion, a likewise elevated stress and crack driving force would develop in the film. However, due to plastic deformation of the a-Li$_x$Ge electrode, the stresses in the film are instead limited by the yield stress, thereby drastically reducing the crack driving force. In other words, materials that readily deform plastically during a lithiation cycle, flow rather than fracture. With this point in mind, Fig. 3 shows a comparison of the stresses developed during galvanostatic (C/16) lithiation and delithiation of Si [29] and Ge electrodes. The Ge electrodes flow at a lower stress than their Si counterparts. As shown by Equation (4), even a modest reduction in the yield stress has a big (squared dependence) impact on the crack driving force. Thus, the relatively small flow stress observed for lithiated Ge indicates a key advantage in terms of its resistance to fracture.

The elastic modulus of Li$_x$Ge can be determined by the change in stress in the electrode during the elastic unloading (and reloading) segments of the lithiation cycles, as was done in previous studies [29,35,39]. The elastic modulus of the Li$_x$Ge film, $E_f$, is given by

$$E_f = -\frac{\Delta \sigma}{\beta \Delta s},$$  \hspace{2cm} (5)

where $\psi$ is Poisson’s ratio of the film and $\Delta \sigma/\Delta s$ is the increment in stress over a sufficiently small change in state of charge [29]. For the calculations, we take $\psi = 0.28$, the value for pure Ge [55]. It is unlikely that this value changes dramatically with lithium concentration, as evidenced in a similar study on Li$_x$Si [44]. The values are in the range of $E_f = 22 - 36$ GPa for our samples, as shown in Table 1. We also performed nanoindentation measurements on the as-deposited a-Ge films, finding a value of $E_f = 95 \pm 10$ GPa, which is similar to those reported in literature for a-Ge [60,61]. As the values for lithiated germanium are much smaller than that of pure Ge, it is evident that even a small amount of lithium insertion into a-Ge results in a large change in elastic modulus. Further increases in lithium concentration seem to lead to a more gradual change of the elastic modulus.

<table>
<thead>
<tr>
<th>Thickness (nm)</th>
<th>x in Li$_x$Ge</th>
<th>E (GPa)</th>
<th>$\Gamma$ (J m$^{-2}$)</th>
</tr>
</thead>
<tbody>
<tr>
<td>100</td>
<td>0.3</td>
<td>23$^*$</td>
<td>–</td>
</tr>
<tr>
<td>320</td>
<td>0.3</td>
<td>25$^*$</td>
<td>8.0</td>
</tr>
<tr>
<td>1160</td>
<td>1.6</td>
<td>22</td>
<td>5.6</td>
</tr>
</tbody>
</table>

We have also investigated fracture of Li$_x$Ge electrodes under these lithiation conditions. In particular, it was found that the 1160 nm film completely pulverized and delaminated from its substrate after one lithiation/delithiation cycle, which is consistent with the reduction in stress to approximately zero at $x = 1.3$ (Fig. 1). The other two films did not show such obvious pulverization or reduction to zero stress. However, observation in an optical microscope indicated that the 320 nm film also fractured after one cycle, while the 100 nm film did not, as shown in Fig. 4.

As discussed extensively in our previous work, when a dense set of cracks forms in a film, the curvature of the substrate decreases correspondingly, i.e., the cracks make the stress in the film appear more compressive than it actually is [29]. We believe that fracture is responsible for the peaks evident in Fig. 1b for the 320 and 1160 nm films. In other words, the peaks in the stress correspond to the critical conditions for the onset of fracture. The validity of this approach for determining the fracture energy of a thin film has been discussed in our previous work [29]. Fracture of these films initially occurs in the form of long channel cracks that extend through the thickness of the film. For such cracks, the fracture energy of the films can be determined with an analysis from Ref. [57]: the energy
release rate for channeling cracks in an elastic thin film bonded to an elastic substrate is given by

\[ G = g(\alpha, \beta) \frac{\sigma_f h_t}{E_f}, \tag{6} \]

where \( E_f = E_t (1 - \nu_t^2) \) is the plane-strain modulus of the film and \( g(\alpha, \beta) \) is a dimensionless parameter that is a function of the Dundurs parameters, \( \alpha \) and \( \beta \), defined by

\[ \alpha = \frac{E_t - E_f}{E_t + E_f}, \quad \beta = \frac{\mu_f (1 - 2\nu_t) - \mu_t (1 - 2\nu_t)}{2\mu_t (1 - \nu_t) + 2\mu_t (1 - \nu_t)}, \tag{7} \]

In these expressions, the \( E_f = E_t / (1 - \nu_t^2) \) represent the respective plane-strain moduli and the \( \mu_f = E_t / [2(1 + \nu_t)] \) represent the shear moduli [57]. To determine the fracture energy, we calculate the energy release rate at the critical conditions for fracture, i.e., at the peaks in the stress for the 320 and 1160 nm films. The stress at the critical lithium concentration is taken from Fig. 1b, the corresponding film thickness is calculated using Equation (3), and the elastic modulus is taken from Table 1. The dimensionless parameter \( g(\alpha, \beta) \) is interpolated from Refs. [57], yielding \( g(\alpha, \beta) = 0.94 \) for the 320 nm film and \( g(\alpha, \beta) = 0.91 \) for the 1160 nm film. The corresponding fracture energies are then \( \Gamma = 8.0 \cdot J \cdot m^{-2} \) for a-Li0.3Ge and \( \Gamma = 5.6 \cdot J \cdot m^{-2} \) for a-Li0.3Ge.

These values are typical for brittle fracture and are in fact similar to the fracture toughness of pure Ge. Indeed, the critical stress intensity factor of single-crystalline Ge is \( K_{IC} = 1.004 \cdot MPa \cdot m^{1/2} \) for the (110) fracture plane. Using a Poisson’s ratio of 0.28 and a stiffness in the [110] direction of 138 GPa in Irwin’s equation yields \( \Gamma = K_{IC}^2 (1 - \nu_t^2) / E_t = 6.7 \cdot J \cdot m^{-2} \) [62]. However, unlike pure Ge, a-Li0.3Ge is capable of extensive plastic flow during electrochemical cycling, as evidenced in Fig. 1b. In other words, a-Li0.3Ge has a peculiar combination of properties – a-Li0.3Ge has the ability to flow plastically, but undergoes brittle fracture. This combination of properties was also found in a-Li0.3Si in our previous work [63]. These seemingly paradoxical characteristics of lithiated silicon were reconciled by the observation that plastic flow in a-Li0.3Si is rate sensitive [63]: plastic flow at larger strain rates (such as those in the vicinity of a crack tip when the crack propagates) requires larger stresses in a-Li0.3Si. As a result, the strains associated with fracture are primarily elastic, resulting in brittle fracture. It is likely that a similar mechanism is responsible for the behavior of a-Li0.3Ge, but further studies similar to that in Ref. [63] are necessary to confirm this notion.

The fracture energy of a-Li1.6Ge is similar to the fracture energy of a-Li0.3Si measured in our previous work – \( \Gamma = 8.0 \cdot J \cdot m^{-2} \) for a-Li0.3Ge and \( \Gamma = 5.6 \cdot J \cdot m^{-2} \) for a-Li0.3Si, as compared to \( \Gamma = 8.5 \cdot J \cdot m^{-2} \) for a-Li0.3Ge and \( \Gamma = 5.4 \cdot J \cdot m^{-2} \) for a-Li2.8Si [29]. Thus, it may seem that Ge and Si electrodes are comparable in terms of resistance to fracture in electrochemical applications. However, as discussed above and shown in Fig. 3, the flow stress of a-Li0.3Ge is substantially less than that of a-Li0.3Si. Consequently, the crack driving force during electrochemical cycling is significantly lower for a-Li0.3Ge, as evident from Equation (4). As an example, the flow stress in the fully lithiated state is \( \sigma_f = 411 \cdot MPa \) for a-Li1.6Si and \( \sigma_f = 274 \cdot MPa \) for a-Li0.3Ge (both defined in compression here to enable a fair comparison). Thus, the difference in flow stresses alone results in lithiated silicon having 2.3 times the driving force for fracture of lithiated germanium, ceteris paribus. This difference in the crack driving force is consistent with recent observations of “tough” Ge nanoparticles [49,50]. In particular, Lee et al. [50] found a critical diameter for lithiation-induced fracture of \(<111>\) c-Ge micro-pillars of \(<1.2 \cdot \mu m\), which was much larger than the corresponding critical diameter of \(<300 \cdot nm\) that they found in \(<111>\) c-Si micro-pillars [25]. The authors attributed this difference to the highly anisotropic deformation found during lithiation of c-Si micro-pillars, as compared to the nearly isotropic deformation found during lithiation of c-Ge micro-pillars. From their modeling, the anisotropic deformation in Si was found to lead to stress concentrations that are on the order of two to three times larger than those found during the nearly isotropic lithiation of Ge (assuming the same flow stress) [50]. Our results demonstrate clearly that the relative “toughness” of c-Ge electrodes is not due to an enhanced fracture toughness of Li0.3Ge over Li0.3Si, but is instead due to the relatively low flow stress of Li0.3Ge, in addition to the fairly isotropic deformation observed during electrochemical cycling [49,50].

4. Conclusions

We have performed in-situ measurements of the stresses, stiffness, and fracture energy of a-Li1.6Ge thin-film electrodes during electrochemical cycling. The a-Li1.6Ge electrodes were observed to flow plastically at stresses smaller than those found in a-Li0.3Si electrodes, resulting in a comparatively small crack driving force in a-Li1.6Ge. While 100 nm films of Ge survive a cycle of lithiation and delithiation, thicker films fracture. The fracture energies were determined from the critical conditions for crack formation to be \( \Gamma = 8.0 \cdot J \cdot m^{-2} \) for a-Li0.3Ge and \( \Gamma = 5.6 \cdot J \cdot m^{-2} \) for a-Li0.3Ge, indicating brittle fracture similar to that of pure Ge. Thus, a-Li0.3Ge exhibits the peculiar ability to flow plastically, but fracture in a brittle manner. Overall, these measurements provide quantitative guidelines for the practical design of germanium electrodes that avoid fracture. Gen-
eraly speaking, Ge electrodes are more resilient to fracture than their Si counterparts, thereby rendering Ge a viable candidate as anode material for lithium-ion batteries.

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